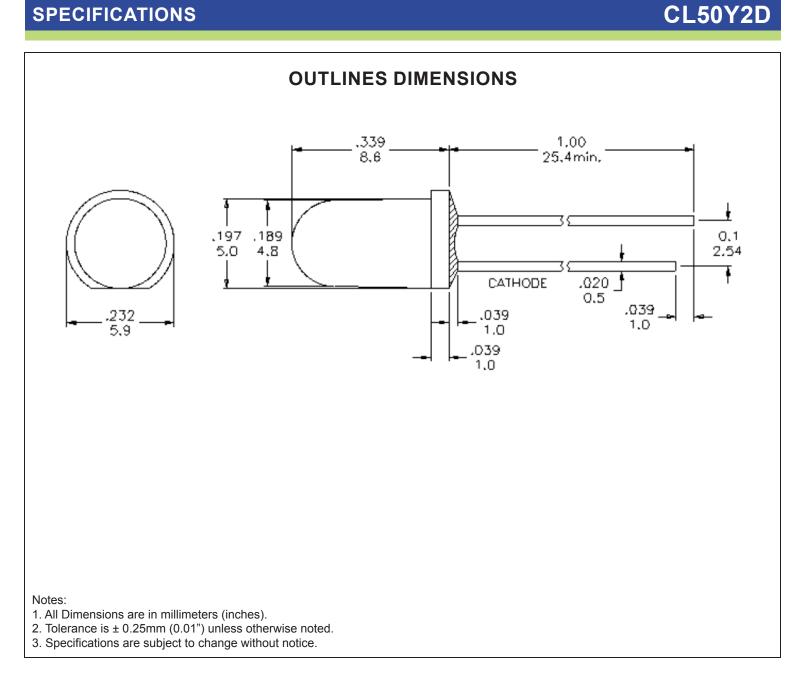


SPECIFICATIONS



| Part Number | Chip Material | Color of Emission | Lens Type | Viewing Angle |
|-------------|---------------|-------------------|-----------------|---------------|
| CL50Y2D | InGaAIP | Yellow | Yellow Diffused | 45° |





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

(TA=25°C)

| Parameter | Symbol | Max Rating | Unit | | |
|---|--------|------------|------|--|--|
| Power Dissipation | PD | 72 | mW | | |
| Pulse Current Forward Current | lfp | 100 | mA | | |
| Continuous Forward Current | lF | 30 | mA | | |
| Reverse Voltage | Vr | 5 | V | | |
| Operating Temperature Range | Topr | -40~+80 | °C | | |
| Storage Temperature Range | Тѕтс | -40~+100 | °C | | |
| IFP = Pulse Width \leq 10 ms, Duty Ratio \leq 1/10. Soldering Condition: 260 °C/ 5sec | | | | | |

OPTICAL-ELECTRICAL CHARACTERISTICS

Value **Test Condition** Parameter Symbol Unit Min Тур Max 220 350 Luminous Intensity Iv I_F = 20mA mcd Forward Voltage I⊧ = 10mA 2.0 2.4 V VF _ 50 **Reverse Leakage Current** $V_R = 5V$ _ IR _ μA **Viewing Angle** $2\theta 1/2$ I_F = 10mA 45 _ _ deg I⊧ = 10mA 588 **Dominant Wavelength** _ λD _ nm

*Tolerance of viewing angle: -10 / +5 deg.





OPTICAL CHARACTERISTIC CURVES

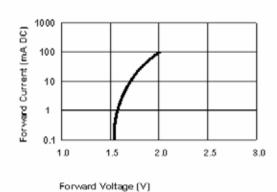
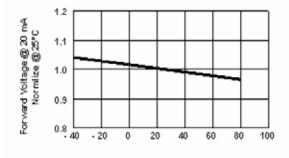


Fig 1. Forward Current vs. Forward Voltage



Fig 3. Forward Voltage vs. Temperature



Ambient Temperature (°C)

Fig5.Relative Intensity Vs.Wavelength

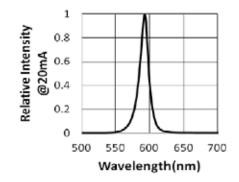
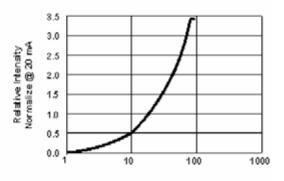
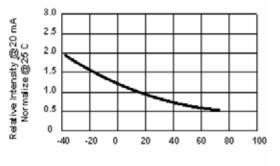


Fig 2. Relative Intensity vs. Forward Current



Forward Current(mA)

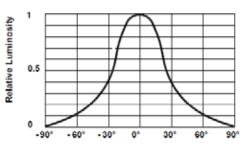




Ambient Temperature(°C)

Fig6.Relative Luminous Intensity Vs.

RadRadiation



Radiation Angle

RoHS Compliant

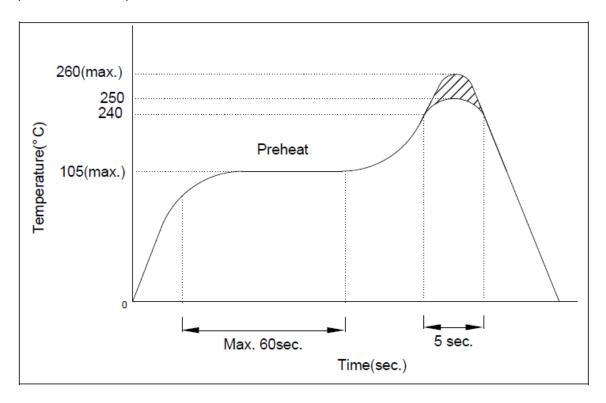


SOLDERING CONDITIONS – LAMP TYPE LED

PRECAUTION FOR USE

- 1. Recommended Soldering Condition
 - 1.1 Wave Soldering

Basic spec is ≤ 5 sec. when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1 sec).



1.2 Soldering Iron

Power dissipation of iron should be smaller than 15W and temperature should be controllable. Surface temperature of iron tip should be under 230° C, soldering time ≤ 3 sec.

2. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs. Use of conductive wrist band or anti-electrostatic glove when handling these LEDs is recommended. All devices, equipment, work table, storage rack and machinery must be properly grounded.

In the events of manual working in process, make sure devices are well protected from ESD at all times.

